

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: **Yoshimichi YAMANAKA**

Serial No.: **Not Yet Assigned**

Filed: **May 15, 2001**

For: **PRIMER COMPOSITION AND BONDING METHOD**

**PRELIMINARY AMENDMENT**

Commissioner for Patents  
Washington, D.C. 20231

May 15, 2001

Sir:

Prior to the calculation of the filing fees of the above application, please amend the application as follows:

**IN THE CLAIMS:**

Please amend claims 4, 5, 10-12, 16, 18-22 and 27-29, as follows:

4. The primer composition according to Claim 1 or 2  
comprising a hydrosilylation catalyst as (F) component.
5. The primer composition according to Claim 1 or 2  
comprising an organic solvent as (G) component.
10. The primer composition according to Claim 6 or 7  
wherein the (B) component silane coupling agent has at least one functional group  
selected from the group consisting of epoxy, vinyl and (meth)acryloyl groups.

11. The primer composition according to Claim 6 or 7  
comprising a hydrosilylation catalyst as (F) component.
12. The primer composition according to Claim 6 or 7  
comprising an organic solvent as (G) component.
16. The bonding method according to Claim 13 or 14  
wherein said curable composition has a curing agent containing two or more silicon-  
bound hydrogen atoms per molecule.
18. The bonding method according to Claim 13 or 14  
wherein said primer composition comprises a polyvalent alkoxysilane and/or a  
condensation product thereof as (C) component.
19. The bonding method according to Claim 13 or 14  
wherein said primer composition comprises an organoaluminum compound and/or  
an organotitanium compound as (D) component.
20. The bonding method according to Claim 13 or 14  
wherein said primer composition comprises a hydrosilylation catalyst as (F)  
component.

21. The bonding method according to Claim 13 or 14  
wherein said primer composition comprises an organic solvent as (G) component.
22. A laminate as obtainable by the bonding method according to Claim 13 or 14.
27. The bonding method according to Claim 23 or 24  
wherein said primer composition comprises a hydrosilylation catalyst as (F)  
component.
28. The bonding method according to Claim 23 or 24  
wherein said primer composition comprises an organic solvent as (G) component.
29. A laminate as obtainable by the bonding method according to Claim 23 or 24.

REMARKS

The above amendment is believed to place the claims in proper condition for examination.  
Early and favorable action is awaited.

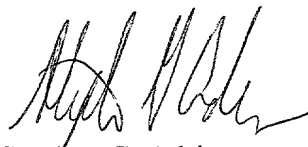
Claims 4-5, 10-12, 16, 18-22 and 27-29, have been amended to remove improper multiple dependent claims.

Attached hereto is a marked-up version of the changes made to the claims by the current amendment. The attached page is captioned "Version with markings to show changes made."

In the event there are any additional fees required, please charge our Deposit Account No. 01-2340.

Respectfully submitted,

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VERSION WITH MARKINGS TO SHOW CHANGES NAME

Claims 4-5, 10-12, 16, 18-22 and 27-19 have been amended as follows:

4. The primer composition according to Claim 1[, 2 or 3] or 2 comprising a hydrosilylation catalyst as (F) component.
5. The primer composition according to [any of Claims 1 to 4] Claim 1 or 2 comprising an organic solvent as (G) component.
10. The primer composition according to [any of Claims 6 to 10] Claim 6 or 7 wherein the (B) component silane coupling agent has at least one functional group selected from the group consisting of epoxy, vinyl and (meth)acryloyl groups.
11. The primer composition according to [any of Claims 6 to 10] Claim 6 or 7 comprising a hydrosilylation catalyst as (F) component.
12. The primer composition according to [any of Claims 6 to 11] Claim 6 or 7 comprising an organic solvent as (G) component.
16. The bonding method according to [any of Claims 13 to 15] Claim 13 or 14 wherein said curable composition has a curing agent containing two or more silicon-bound hydrogen atoms per molecule.
18. The bonding method according to [any of Claims 13 to 17] Claim 13 or 14 wherein said primer composition comprises a polyvalent alkoxysilane and/or a condensation product thereof as (C) component.

19. The bonding method according to Claim 13 [to 18] or 14  
wherein said primer composition comprises an organoaluminum compound and/or  
an organotitanium compound as (D) component.
20. The bonding method according to [any of Claims 13 to 19] Claim 13 or 14  
wherein said primer composition comprises a hydrosilylation catalyst as (F)  
component.
21. The bonding method according to [any of Claims 13 to 20] Claim 13 or 14  
wherein said primer composition comprises an organic solvent as (G) component.
22. A laminate as obtainable by the bonding method according to [any of Claims 13 to  
20] Claim 13 or 14.
27. The bonding method according to [any of Claims 23 to 26] Claim 23 or 24  
wherein said primer composition comprises a hydrosilylation catalyst as (F)  
component.
28. The bonding method according to [any of Claims 23 to 27] Claim 23 or 24  
wherein said primer composition comprises an organic solvent as (G) component.
29. A laminate as obtainable by the bonding method according to [any of Claims 23 to  
28] Claim 23 or 24.